

## 1N4001 - 1N4007

#### **Features**

- Low forward voltage drop.
- · High surge current capability.



## 1.0 Ampere General Purpose Rectifiers

## Absolute Maximum Ratings\* T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter	Value	Units A	
I <sub>F(AV)</sub>	Average Rectified Current .375 " lead length @ T <sub>A</sub> = 75°C	1.0		
I <sub>FSM</sub>	Non-repetitive Peak Forward Surge Current 8.3 ms single half-sine-wave Superimposed on rated load (JEDEC method)	30	А	
$P_D$	Total Device Dissipation Derate above 25°C	2.5 20	W mW/°C	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	50	°C/W	
T <sub>stg</sub>	Storage Temperature Range	-55 to +175	°C	
TJ	Operating Junction Temperature	-55 to +150	°C	

<sup>\*</sup>These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

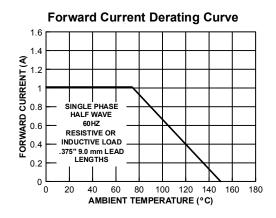
## Electrical Characteristics T<sub>A</sub> = 25°C unless otherwise noted

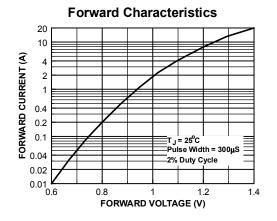
Symbol	l Parameter		Device					Units	
		4001	4002	4003	400	400	4006	4007	
$V_{RRM}$	Peak Repetitive Reverse Voltage	50	100	200	400	600	800	1000	V
V <sub>RMS</sub>	Maximum RMS Voltage		70	140	280	420	560	700	V
V <sub>R</sub>	DC Reverse Voltage (Rated V <sub>R</sub> )		100	200	400	600	800	1000	V
I <sub>RM</sub>	Maximum Instantaneous Reverse Current @ rated $V_R$ $T_A = 25^{\circ}C$ $T_A = 100^{\circ}C$		5.0 500					μ <b>Α</b> μ <b>Α</b>	
V <sub>FM</sub>	Maximum Instantaneous Forward Voltage @ 1.0 A		1.1					V	
Irr	Maximum Full Load Reverse Current, Full Cycle T <sub>A</sub> = 75°C		30					μА	
С	Typical Junction Capacitance V <sub>R</sub> = 4.0 V, f = 1.0 MHz		15				pF		

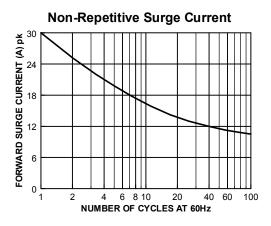
## **General Purpose Rectifiers**

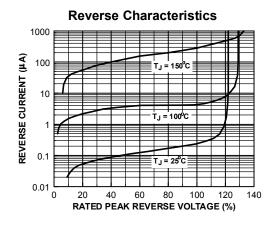
(continued)

## **Typical Characteristics**





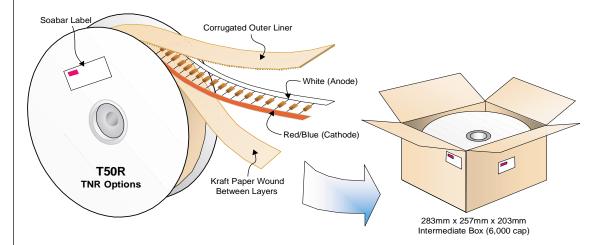




### DO-41 (Glass) Tape and Ammo Data



## DO-41 (Glass) Packaging Configuration: Figure 1.0



## DO-41 (Glass) Packaging Information

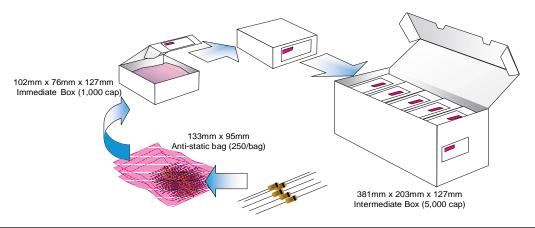
Table: Figure 2.0

DO-41 (Glass) Packaging Information					
Packaging Option	T50R	T50A	Standard (no flow code)		
Packaging type	TNR	Ammo	Bag		
Qty per Reel/Tube/Bag	3,000	3,000	250		
Reel Size (inch diameter)	10.5	-	-		
Inside Tape Spacing (mm)	52	52	-		
Int Box Dimension (mm)	283x257x203	406x267x184	381x203x127		
Max qty per Box	6,000	30,000	5,000		
Weight per unit (gm)	0.320	0.320	0.320		
Weight per Reel (kg)	1.356	1.077	-		
Note/Comments			Bulk		

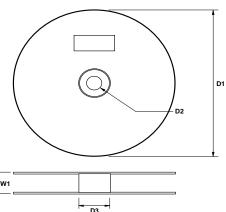
#### Soabar Label sample

SEMICO	NDUCTOR 14	P.O. No.	
TYPE	1N4744A	MARK	BLK-BRN
REV	A2	PART No.	
PKG		EC No.	
QTY	3,000	M.O. No.	OX5046F035
Q.C.		DATE	D9903
MFD. UN	DER US PAT 3.025.589	& OTHER US PATS 8	APPLICATIONS

# **DO-41 (Glass) Bulk Packing Configuration:** Figure 3.0



#### DO-41 (Glass) Tape and Ammo Data, continued DO-41 (Glass) Ammo Packing Configuration: Figure 4.0 254mm x 79mm x 79mm Immediate Container (3,000 cap) T50A Option 406mm x 267mm x 184mm rmediate Container (50,000 cap) for T50A option DO-41 (Glass) Taping **Dimension:** Figure 5.0 TAPING DIMENSIONS NOTES INCH MILS Overall width 2.047±0.027 52 ±0.69 2047±27 Inside Tape Spacing 0.200 ±0.0157 5.08 ±0.40 200 ±15.7 Component Pitch 0.047(max) 1.2(max) 47(max) Component Misalignmen 0.022(max) 0.55(max) 22(max) Tape Mismatch 0.027(max) ±0.69 ±27 Units in line w/ one another 0.126(min) 3.2(min) 126(min) Lead amount between tapes Lead amount beyond tapes L1-L2 ±0.027 ±0.69 ±27 Delta between two leads DO-41 (Glass) Reel Dimension: Figure 6.0



REEL DIMENSIONS ITEM DESCRIPTION	SYMBOL	MINIMUM	MAXIMUM
Reel Diameter	D1	10.375	10.625
Arbor Hole Diameter (Standard)	D2	1.245	1.255
Core Diameter	D3	3.190	3.310
Flange to Flange Outer Width	W1		3.400

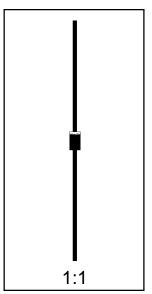
Note: All Dimensions are in inches

## **DO-41 (Glass) Package Dimensions**



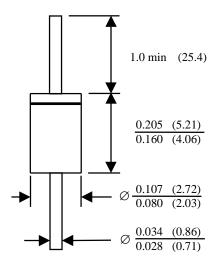
# DO-41 (FS PKG Code D4)





Scale 1:1 on letter size paper
Dimensions shown below are in:
inches [millimeters]

Part Weight per unit (gram): 0.32



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